

1.6X0.8mm SMD CHIP LED LAMP

Part Number: APT1608SECK

Super Bright Orange

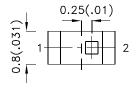
Features

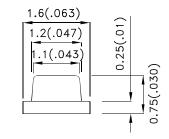
- 1.6mmX0.8mm SMT LED, 0.75mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package: 2000pcs / reel .
- Moisture sensitivity level : level 3.
- RoHS compliant.

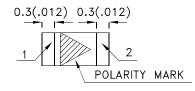
Description

The Super Bright Orange device is made with AlGaInP (on GaAs substrate) light emitting diode chip.

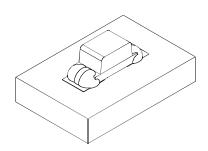
Package Dimensions











- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.





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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		2.	Min.	Тур.	201/2
APT1608SECK	Super Bright Orange (AlGaInP)		120	250	120°

- Notes: 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

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Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions		
λpeak	Peak Wavelength	Super Bright Orange	610		nm	IF=20mA		
λD [1]	Dominant Wavelength	Super Bright Orange	601		nm	IF=20mA		
Δλ1/2	Spectral Line Half-width	Super Bright Orange	29		nm	IF=20mA		
С	Capacitance	Super Bright Orange	15		pF	V _F =0V;f=1MHz		
VF [2]	Forward Voltage	Super Bright Orange	2.1	2.5	V	IF=20mA		
lr	Reverse Current	Super Bright Orange		10	uA	V _R =5V		

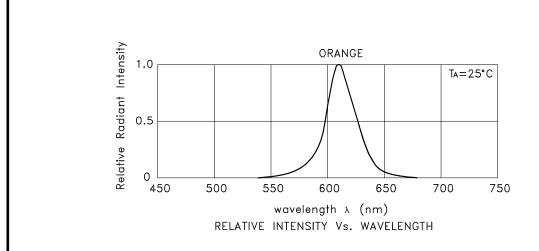
- Notes: 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

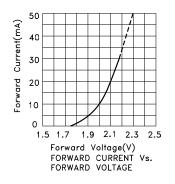
Super Bright Orange	Units	
75	mW	
30	mA	
195	mA	
5	V	
-40°C To +85°C		
-40°C To +85°C		
	75 30 195 5 -40°C To +85°C	

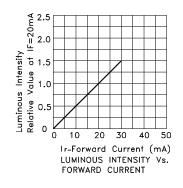
Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

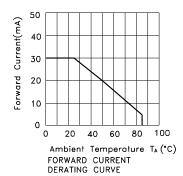
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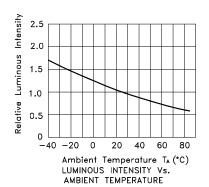


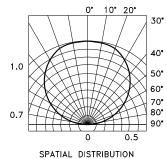
Super Bright Orange APT1608SECK











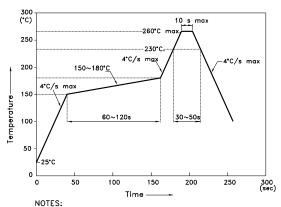
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APT1608SECK

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

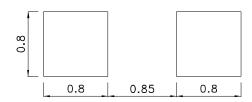
Reflow Soldering Profile For Lead-free SMT Process.



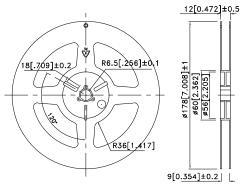
- NOTES: 1.We recommend the reflow temperature 245°C(\pm /-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

 3.Number of reflow process shall be 2 times or less.

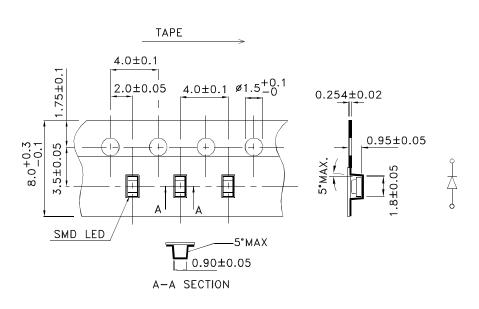
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



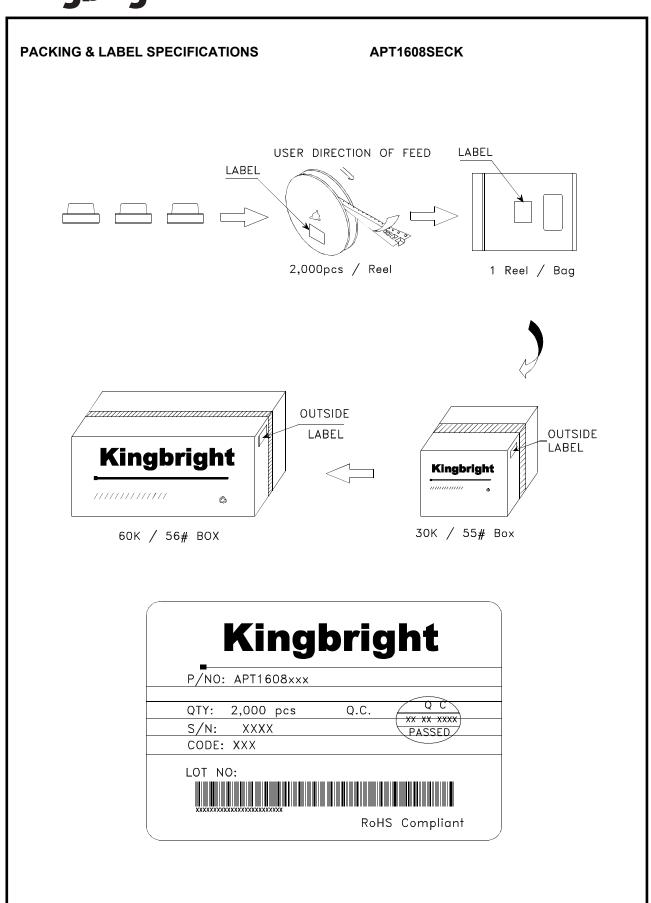
Reel Dimension



Tape Dimensions (Units: mm)



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